

BIBDATASHEET

CONFIRMATION NO. 8484

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** FOREIGN APPLICATIONS ************************************					
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ADDRESS 08834 WESTERMAN, HATTORI, DANIELS & ADRIAN, LLP 1250 CONNECTICUT AVENUE, NW SUITE 700 WASHINGTON , DC 20038					
TITLE Resist pattern thickening semiconductor devices	g material, process for	forming resist pattern,	and process to	a waungschi	ing
	UNG FEE FEES: Authority has been given in Paper				